



#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

# **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
20V	$23m\Omega$ @ $V_{GS} = 4.5V$	5.2A
	27mΩ @ V <sub>GS</sub> = 2.5V	4.8A

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

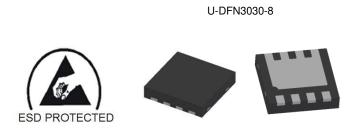
https://www.diodes.com/quality/product-definitions/

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

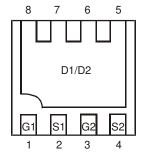
### **Mechanical Data**

- Case: U-DFN3030-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208@4
- Polarity: See Diagram
- Weight: 0.0172 grams (Approximate)

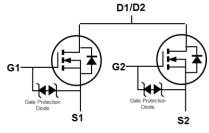


Top View

**Bottom View** 



Bottom View Pin Configuration



**Equivalent Circuit** 

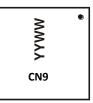
### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN2024UDH-7	U-DFN3030-8	3000/Tape & Reel

Notes:

- $1.\ No\ purposely\ added\ lead.\ Fully\ EU\ Directive\ 2002/95/EC\ (RoHS),\ 2011/65/EU\ (RoHS\ 2)\ \&\ 2015/863/EU\ (RoHS\ 3)\ compliant.$
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



CN9 = Product Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 20 for 2020) WW = Week Code (01 to 53)



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characte	ristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	20	V	
Gate-Source Voltage		Vgss	±10	V	
Continuous Drain Current (Note 5) Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			ID	5.2 4.2	Α
Pulsed Drain Current		I <sub>DM</sub>	45	Α	
Avalanche Current (Note 7) L = 0.1mH	I <sub>AS</sub>	12	Α		
Avalanche Energy (Note 7) L = 0.1mH	Eas	8	mJ		

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.95	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RеJA	132	°C/W
Total Power Dissipation (Note 6) $T_A = +25$ °C		PD	1.76	W
Thermal Resistance, Junction to Ambient (Note 6) Steady State		$R_{\theta JA}$	71	°C/W
Thermal Resistance, Junction to Case (Note 6) Stead		Rелс	14	- C/VV
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

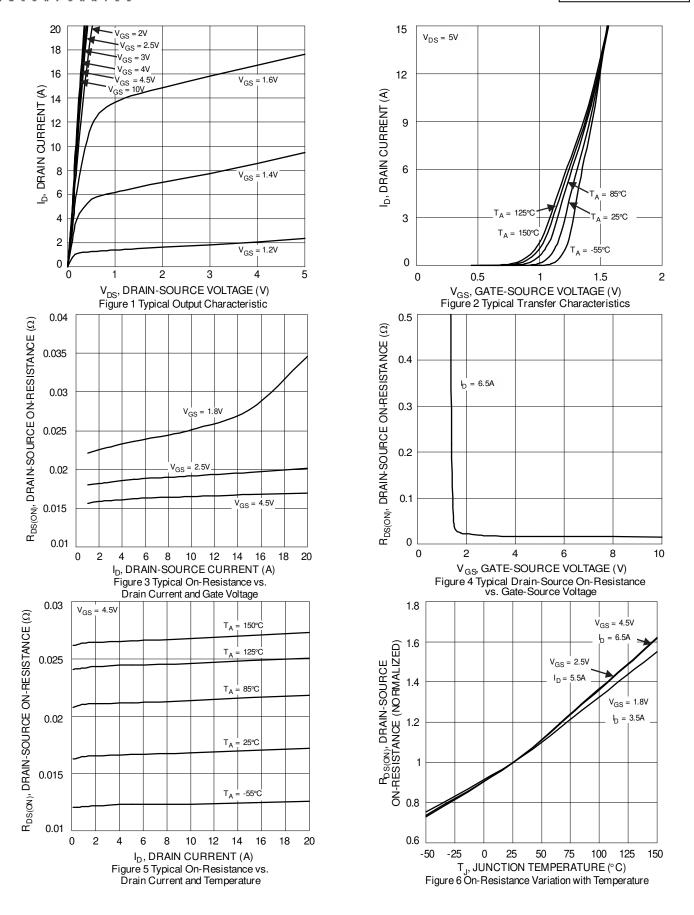
# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	1	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C		_	-	1.0	μΑ	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	1	±10	μΑ	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(TH)}$	0.35	1	1.0	٧	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
		_	16	23	mΩ	$V_{GS} = 4.5V, I_{D} = 6.5A$	
Static Drain-Source On-Resistance	RDS(ON)	_	19	27		$V_{GS} = 2.5V, I_{D} = 5.5A$	
	, ,	_	24	34		$V_{GS} = 1.8V, I_D = 3.5A$	
Diode Forward Voltage	VsD	_	0.65	1.0	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS							
Input Capacitance	Ciss	_	647	_	pF	101/1/	
Output Capacitance	Coss	_	78		рF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	38	_	pF		
Gate Resistance	Rg	_	400		Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	6.5	_	nC	V 45V V 40V	
Gate-Source Charge	Qgs	_	1.1	_	nC	Vgs = 4.5V, Vds = 10V,	
Gate-Drain Charge	$Q_{gd}$	_	1.7	_	nC	I <sub>D</sub> = 6.5A	
Turn-On Delay Time	tD(ON)	_	98	_	ns		
Turn-On Rise Time	tr	_	140	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$ $R_{L} = 10\Omega, R_{G} = 6\Omega$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	1024	_	ns		
Turn-Off Fall Time	tF	_	434	_	ns		
Reverse Recovery Time	trr	_	245	_	ns	14 11/11 1004/	
Reverse Recovery Charge	Qrr	_	149	_	nC	I <sub>F</sub> = 1A, di/dt = 100A/μs	

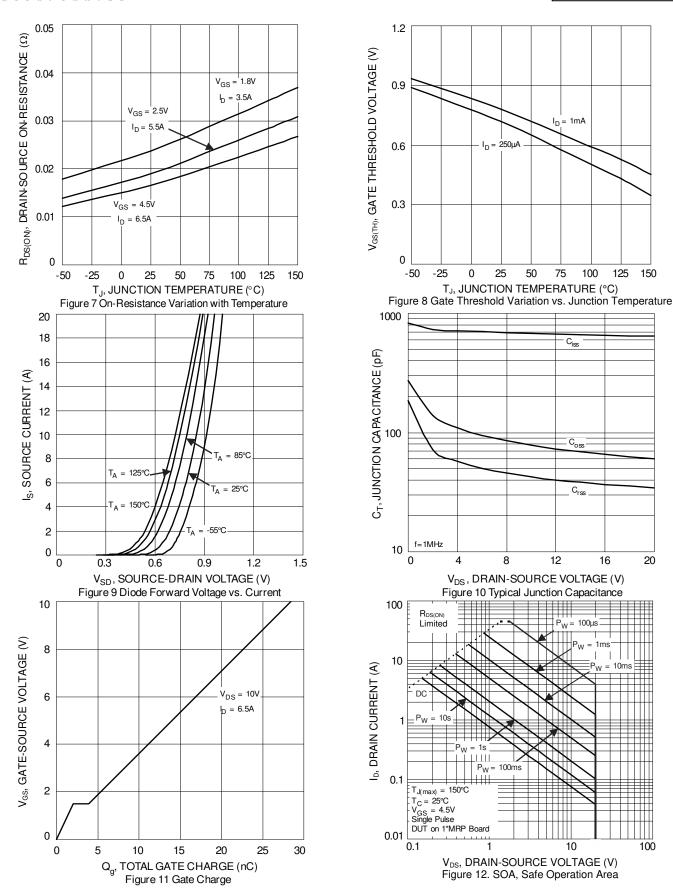
Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.

<sup>6.</sup> Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate. 7. Short duration pulse test used to minimize self-heating effect.





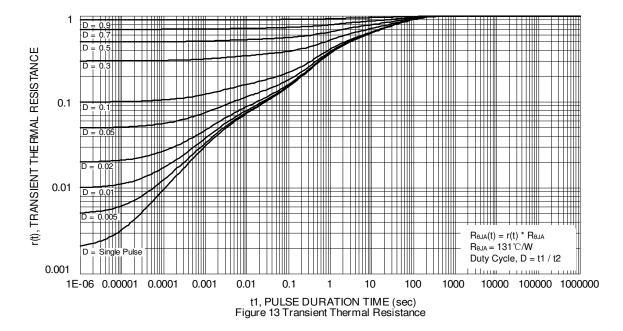




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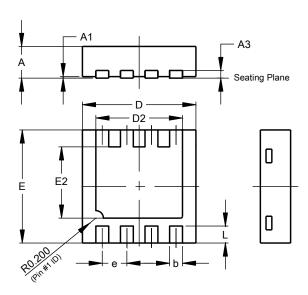




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN3030-8

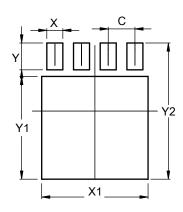


U-DFN3030-8					
Dim	Min	Max	Тур		
Α	0.57	0.63	0.60		
A1	0	0.05	0.02		
А3	-	-	0.15		
b	0.29	0.39	0.34		
D	2.90	3.10	3.00		
D2	2.19	2.39	2.29		
е	-	-	0.65		
Е	2.90	3.10	3.00		
E2	1.64	1.84	1.74		
L	0.30	0.60	0.45		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN3030-8



Dimensions	Value (in mm)		
С	0.650		
X	0.390		
X1	2.590		
Υ	0.650		
Y1	2.490		
Y2	3.300		



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